Lattice Semiconductor Corporation - LFX1200EB-04FE680I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	15376
Total RAM Bits	423936
Number of I/O	496
Number of Gates	1250000
Voltage - Supply	2.3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	680-LBGA
Supplier Device Package	680-FPSBGA (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfx1200eb-04fe680i

Product Line	Ordering Part Number	Product Status	Reference PCN
LFX500B	LFX500B-03F516C	**Discontinued**	PCN#09-10
	LFX500B-04F516C		
	LFX500B-05F516C		
	LFX500B-03F900C		
	LFX500B-03FN900C		
	LFX500B-04F900C		
	LFX500B-04FN900C		
	LFX500B-05F900C		
	LFX500B-05FN900C		
LFX500C	LFX500C-03F516C	**Discontinued**	PCN#09-10
	LFX500C-04F516C		
	LFX500C-03F900C		
	LFX500C-03FN900C		
	LFX500C-04F900C		
	LFX500C-04FN900C		
LFX1200B	LFX1200B-03FE680C	**Discontinued**	PCN#03A-10
	LFX1200B-04FE680C		
	LFX1200B-05FE680C		
	LFX1200B-03F900C		
	LFX1200B-04F900C		
	LFX1200B-05F900C		
LFX1200C	LFX1200C-03FE680C	**Discontinued**	PCN#03A-10
	LFX1200C-04FE680C		
	LFX1200C-03F900C		
	LFX1200C-04F900C		
LFX125EB	LFX125EB-03F256C	Active / Orderable	
	LFX125EB-03FN256C		
	LFX125EB-04F256C		
	LFX125EB-04FN256C		
	LFX125EB-05F256C		
	LFX125EB-05FN256C		
	LFX125EB-03F256I		
	LFX125EB-03FN256I		
	LFX125EB-04F256I		
	LFX125EB-04FN256I		
	LFX125EB-03F516C	**Discontinued**	PCN#09-10
	LFX125EB-04F516C		
	LFX125EB-05F516C		
	LFX125EB-03F516I		
	LFX125EB-04F516I		
LFX125EC	LFX125EC-03F256C	**Discontinued**	PCN#09-10
	LFX125EC-03FN256C		
	LFX125EC-04F256C		
	LFX125EC-04FN256C		
	LFX125EC-03F256I		
	LFX125EC-03FN256I		

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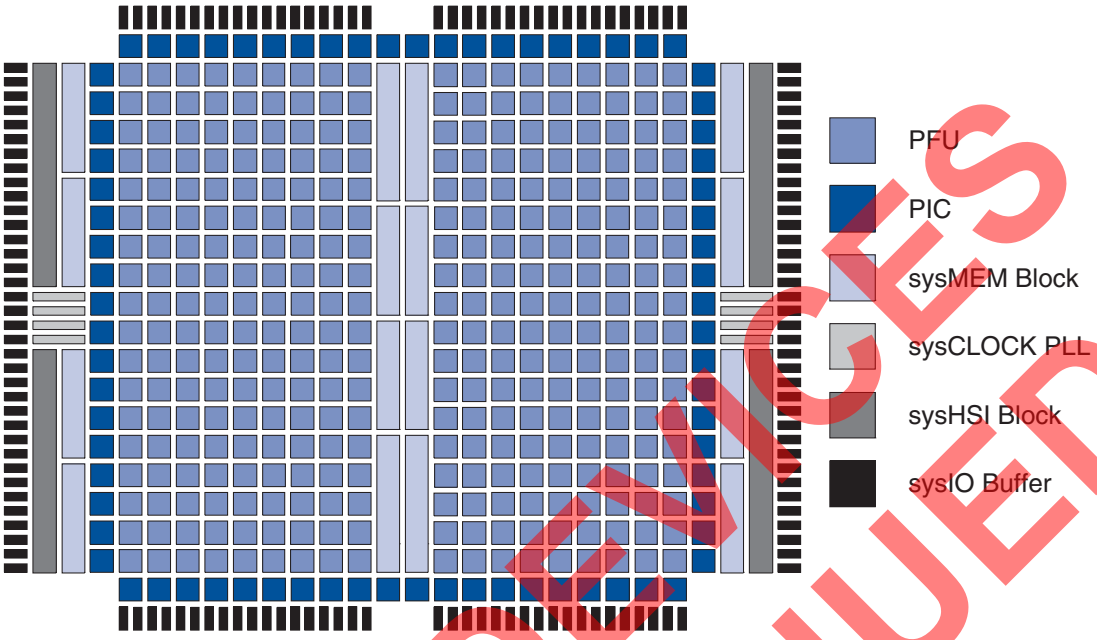
Internet: http://www.latticesemi.com

Product Line	Ordering Part Number	Product Status	Reference PCN
LFX125EC (Cont'd)	LFX125EC-03F516C	**Discontinued**	PCN#09-10
	LFX125EC-04F516C		
	LFX125EC-03F516I		
LFX200EB	LFX200EB-03F256C	Active / Orderable	
	LFX200EB-03FN256C		
	LFX200EB-04F256C		
	LFX200EB-04FN256C		
	LFX200EB-05F256C		
	LFX200EB-05FN256C		
	LFX200EB-03F256I		
	LFX200EB-03FN256I		
	LFX200EB-04F256I		
	LFX200EB-04FN256I		
	LFX200EB-03F516C	**Discontinued**	PCN#09-10
	LFX200EB-04F516C		
	LFX200EB-05F516C		
	LFX200EB-03F516I		
	LFX200EB-04F516I		
LFX200EC	LFX200EC-03F256C	**Discontinued**	PCN#09-10
	LFX200EC-03FN256C		
	LFX200EC-04F256C		
	LFX200EC-04FN256C		
	LFX200EC-03F256I		
	LFX200EC-03FN256I		
	LFX200EC-03F516C		
	LFX200EC-04F516C		
	LFX200EC-03F516I		
LFX500EB	LFX500EB-03F516C	**Discontinued**	PCN#09-10
	LFX500EB-04F516C		
	LFX500EB-05F516C		
	LFX500EB-03F516I		
	LFX500EB-04F516I		
	LFX500EB-03F900C		
	LFX500EB-03FN900C		
	LFX500EB-04F900C		
	LFX500EB-04FN900C		
	LFX500EB-05F900C		
	LFX500EB-05FN900C		
	LFX500EB-03F900I		
	LFX500EB-03FN900I		
	LFX500EB-04F900I		
	LFX500EB-04FN900I		
LFX500EC	LFX500EC-03F516C	**Discontinued**	PCN#09-10
	LFX500EC-04F516C		
	LFX500EC-03F516I		

Figure 1. ispXPGA Block Diagram



Programmable Function Unit

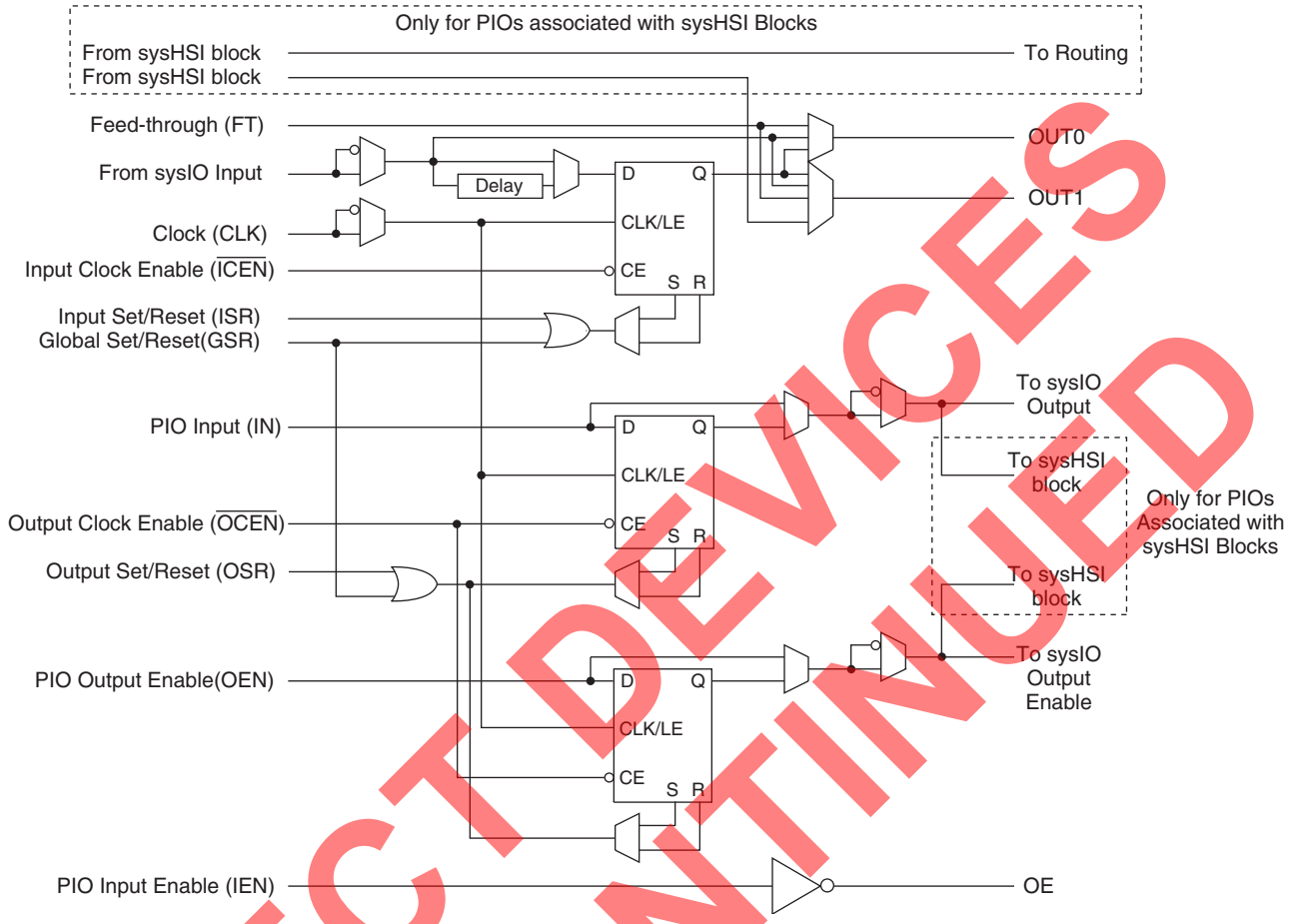
The Programmable Function Unit (PFU) is the basic building block of the ispXPGA architecture. The PFUs are arranged in rows and columns in the device with PFU (1,1) referring to (row 1, column 1). Each PFU consists of four Configurable Logic Elements (CLEs), four Configurable Sequential Elements (CSEs), and a Wide Logic Generator (WLG). By utilizing these components, the PFU can implement a variety of functions. Table 3 lists some of the function capabilities of the PFU.

There are 57 inputs to each PFU and nine outputs. The PFU uses 20 inputs for logic, and 37 inputs drive the control logic from which six control signals are derived for the PFU.

Table 3. Function Capability of ispXPGA PFU

Function	Capability
Look-up table	LUT-4, LUT-5, LUT-6
Wide logic functions	Up to 20 input logic functions
Multiplexing	2:1, 4:1, 8:1
Arithmetic logic	Dedicated carry chain and booth multiplication logic
Single-port RAM	16X1, 16X2, 16X4, 32X1, 32X2, 64X1
Double-port RAM	16X1, 16X2, 32X1
Shift register	8-bit shift registers (up to 32-bit shift capability)

Figure 11. ispXPGA PIO



VLI Routing Resources

The ispXPGA architecture contains a Variable-Length-Interconnect (VLI) routing technology connecting the PFUs, PICs, and EBRs in the device. There are four types of routing resources, Global Lines, Long Lines, General Interconnect, and Local Lines forming the global routing structure. This allows a signal to be routed to any element in the device with the optimal delay.

The Global Lines consist of global clock lines and a global set/reset line. These lines are routed to all elements in the device. They are specifically designed for high speed, predictable timing regardless of fan-out. The global clock lines can also be used as dedicated inputs.

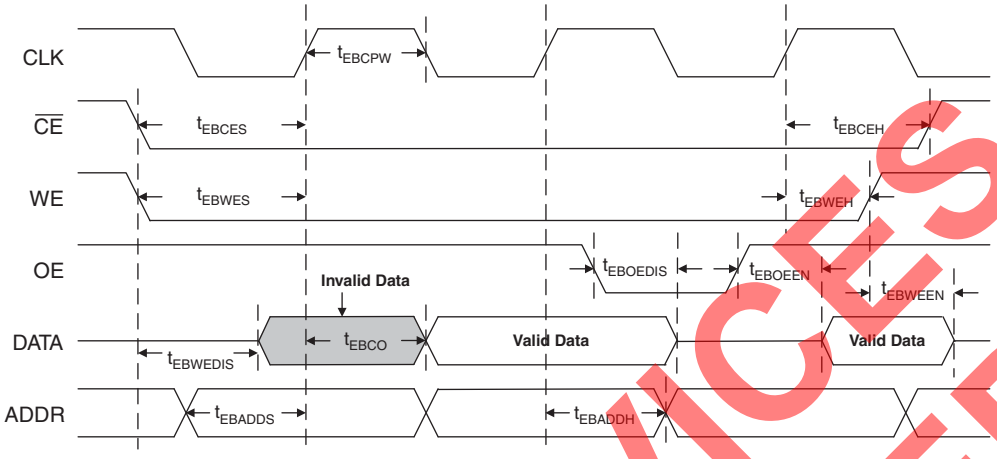
The Long Lines consist of Horizontal and Vertical Long Lines (HLL and VLL). The VLL and HLL are tri-statable lines spanning the entire device. These lines allow fast routing for high fan-out nets and general-purpose functions.

The General Interconnect consists of Double and Deca Lines. The Double Lines connect up to three elements (two plus the driving element), while the Deca Lines connect up to eleven elements (ten plus the driving element).

The Local Lines are extremely fast routing paths consisting of Feedback and Direct Connect Lines. The Feedback Lines are internal routing paths from the PFU outputs to the PFU inputs. The Direct Connect Lines connect all adjacent elements.

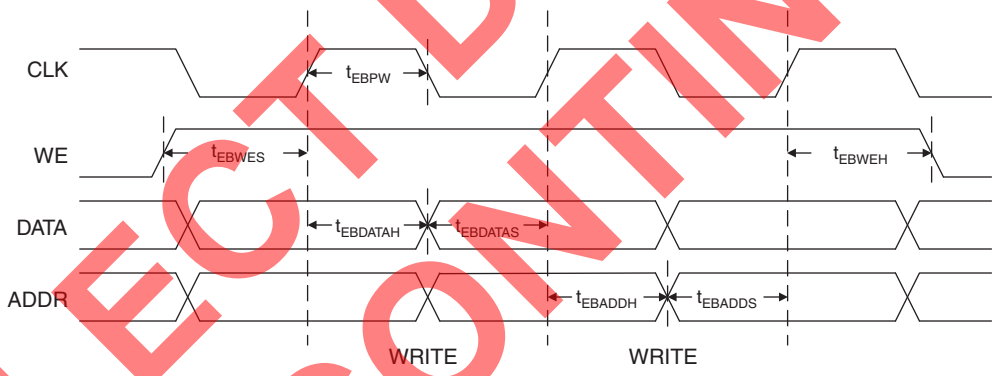
The Common Interface Block (CIB) provides the link between the logic element (PFU, PIC, or EBR) and the VLI Routing resources. The CIB is a switch matrix that can be programmed to connect virtually any routing resource to any input or output of the logic element.

Figure 13. EBR Synchronous Read Timing Diagram



Synchronous Write: The WE signal controls the synchronous write operation. When the WE signal is high, the write operation begins. Once the address and data are present and the Output Enable (OE) is active, a rising clock edge (or falling edge depending on polarity) causes the data to be stored into the EBR. Figure 14 illustrates the synchronous write timing.

Figure 14. EBR Synchronous Write Timing Diagram



Asynchronous Read: The WE signal controls the asynchronous read operation. When the WE signal is low, the read operation begins. Shortly after the address is present, the stored data is available on the DATA port. Figure 15 illustrates the asynchronous read timing. For more information about the EBR, refer to TN1028 ispXPGA Memory Usage Guidelines.

Figure 15. EBR Asynchronous Read Timing Diagram

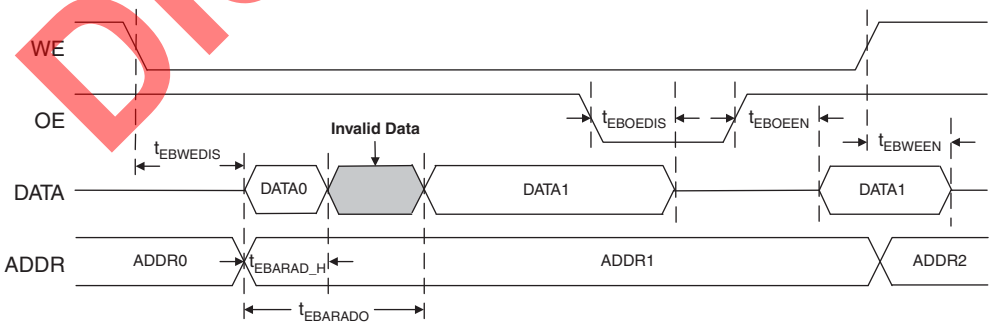


Table 5. ispXPGA Supported I/O Standards

sysIO Standard	V_{CCO}	V_{REF}	V_{TT}
LVTTL	3.3V	N/A	N/A
LVCMOS-3.3	3.3V	N/A	N/A
LVCMOS-2.5	2.5V	N/A	N/A
LVCMOS-1.8	1.8V	N/A	N/A
PCI	3.3V	N/A	N/A
AGP-1X	3.3V	N/A	N/A
SSTL3, Class I, II	3.3V	1.5V	1.5V
SSTL2, Class I, II	2.5V	1.25V	1.25V
HSTL, Class I	1.5V	0.75V	0.75V
HSTL, Class III	1.5V	0.9V	1.5V
GTL+	N/A	1.0V	1.5V
LVPECL	3.3V	N/A	N/A
LVDS[1]	2.5V	N/A	N/A
BLVDS	2.5V	N/A	N/A

1. V_{CCO} must be 2.5V for high speed serial operations (sysHSI block).

Table 6. Differential Interface Standard Support[1]

		sysIO Buffer Not Using sysHSI Block	sysIO Buffer Using sysHSI Block
LVDS	Driver	Supported with external resistor network	Supported
	Receiver	Supported with standard termination	Supported with standard termination
BLVDS	Driver	Supported with external resistor network	Not supported
	Receiver	Supported (may need termination)	Supported (may need termination)
LVPECL	Driver	Supported with external resistor network	Not supported
	Receiver	Supported with termination	Supported with termination

1. For more information, refer to TN1000, sysIO Usage Guidelines for Lattice Devices.

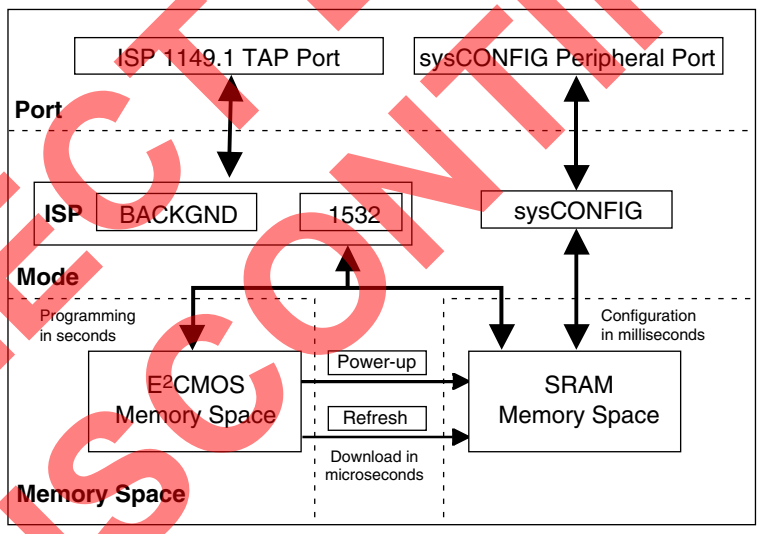
Configuration and Programming

The ispXPGA family of devices takes a unique approach to FPGA configuration memory. It contains two types of memory, Static RAM and non-volatile E²CMOS cells. The static RAM is used to control the functionality of the device during normal operation and the E²CMOS memory cells are used to load the SRAM. The E²CMOS memory module can be thought of as the hard drive for the ispXPGA configuration and the SRAM as the working configuration memory. There is a one-to-one relationship between SRAM memory and the E²CMOS cells. The SRAM can be configured either from the E²CMOS memory or from an external source, as shown in Figure 21.

Figure 21 shows the different ports and modes that are used in the configuration and programming of the ispXPGA devices. There are two possible ports that can be used for configuration of the SRAM memory: the ISP port which supports the IEEE 1149.1 Test Access Port (TAP) Std., accommodates bit-wide configuration. The sysCONFIG port allows byte-wide configuration of the SRAM configuration memory. When programming the E²CMOS memory, only the 1149.1 TAP can be used.

Configuration and programming done through the 1149.1 Test Access Port (TAP) supports both the IEEE Std. 1149.1 Boundary Scan TAP specification and the IEEE Std. 1532 In-System Configuration specification. To configure or program the device using the 1149.1 TAP the device must be in the ISP mode. To configure the SRAM memory using the sysCONFIG Port, the device must be in the sysCONFIG mode. Upon power-up, the device's SRAM memory can be configured either from the E²CMOS memory or from an external source through the sysCONFIG mode. Additionally, the SRAM can be re-configured from the E²CMOS memory by executing a "REFRESH." See TN1026, ispXP Configuration Usage Guidelines, for more in depth information on the different programming modes, timing and wake-up.

Figure 21. ispXP Block Diagram



Supports IEEE 1149.1 Boundary Scan Testability

All ispXPGA devices have boundary scan cells and supports the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic notes. Internal boundary scan registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board level testing.

Security Scheme

A programmable security scheme is provided on the ispXPGA devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, the security scheme prevents read-back of the programmed

sysIO DC Electrical Characteristics

Over Recommended Operating Conditions

Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL} (mA)	I_{OH} (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	5.5	0.4	V_{CCO} - 0.4	20, 16, 12, 8, 5.33, 4	-20, -16,-12, -8, -5.33, -4
					0.2	V_{CCO} - 0.2	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	V_{CCO} - 0.4	16, 12, 8, 5.33, 4	-16, -12, -8, -5.33, -4
					0.2	V_{CCO} - 0.2	0.1	-0.1
LVCMOS 1.8[1]	-0.3	0.68[3]	1.07[3]	3.6	0.4	V_{CCO} - 0.4	12, 8[1], 5.33, 4	-12, -8[1], -5.33, -4
		0.35V_{CC}	0.65V_{CC}		0.2	V_{CCO} - 0.2	0.1	-0.1
LVTTL	-0.3	0.8	2.0	5.5	0.4	V_{CCO} - 0.4	4	-4
					0.2	V_{CCO} - 0.2	0.1	-0.1
PCI 3.3	-0.3	1.08[3]	1.5[3]	5.5	0.1 V_{CCO}	0.9 V_{CCO}	1.5	-0.5
		0.3V_{CCO}	0.5 V_{CCO}					
AGP-1X	-0.3	1.08[3]	1.5[3]	3.6	0.1 V_{CCO}	0.9 V_{CCO}	1.5	-0.5
		0.3 V_{CCO}	0.5 V_{CCO}					
SSTL 3 Class I	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	0.7	V_{CCO} - 1.1	8	-8
SSTL 3 Class II	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	0.5	V_{CCO} - 0.9	16	-16
SSTL 2 Class I	-0.3	V_{REF} - 0.18	V_{REF} + 0.18	3.6	0.54	V_{CCO} - 0.62	7.6	-7.6
SSTL 2 Class II	-0.3	V_{REF} - 0.18	V_{REF} + 0.18	3.6	0.35	V_{CCO} - 0.43	15.2	-15.2
CTT 3.3	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	V_{REF} - 0.4	V_{REF} + 0.4	8	-8
CTT 2.5	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	V_{REF} - 0.4	V_{REF} + 0.4	8	-8
HSTL Class I	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCO} - 0.4	8	-8
HSTL Class III	-0.3	V_{REF} - 0.1	V_{REF} + 0.1	3.6	0.4	V_{CCO} - 0.4	24	-8
GTL+	-0.3	V_{REF} - 0.2	V_{REF} + 0.2	3.6	0.6	N/A	36	N/A

1. Design tool default setting.
2. The average DC current drawn by I/Os between adjacent bank GND connections, or between the last GND in an I/O bank and the end of the I/O bank, as shown in the logic signals connection table, shall not exceed n*8mA. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank
3. Applicable for ispXPGA B devices.

ispXPGA 1200B/C & ispXPGA 1200EB/EC PFU Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Functional Delays								
LUTs								
t_{LUT4}	4-Input LUT Delay	—	0.41	—	0.44	—	0.51	ns
t_{LUT5}	5-Input LUT Delay	—	0.73	—	0.79	—	0.91	ns
t_{LUT6}	6-Input LUT Delay	—	0.86	—	0.93	—	1.07	ns
Shift Register (LUT)								
t_{LSR_S}	Shift Register Setup Time	-0.64	—	-0.62	—	-0.53	—	ns
t_{LSR_H}	Shift Register Hold Time	0.61	—	0.63	—	0.72	—	ns
t_{LSR_CO}	Shift Register Clock to Output Delay	—	0.70	—	0.75	—	0.86	ns
Arithmetic Functions								
$t_{LCTHRUR}$	MC (Macro Cell) Carry In to MC Carry Out Delay (Ripple)	—	0.08	—	0.09	—	0.10	ns
$t_{LCTHRUL}$[2]	MC Carry In to MC Carry Out Delay (Look Ahead)	—	0.05	—	0.05	—	0.06	ns
t_{LSTHRU}	MC Sum In to MC Sum Out Delay	—	0.42	—	0.45	—	0.52	ns
$t_{LSINCOUT}$	MC Sum In to MC Carry Out Delay	—	0.29	—	0.31	—	0.36	ns
$t_{LCINSOUTR}$	MC Carry In to MC Sum Out Delay (Ripple)	—	0.36	—	0.39	—	0.45	ns
$t_{LCINSOUTL}$	MC Carry In to MC Sum Out Delay (Look Ahead)	—	0.26	—	0.28	—	0.32	ns
Feed-thru								
t_{LFT}	PFU Feed-Thru Delay	—	0.15	—	0.16	—	0.18	ns
Distributed RAM								
t_{LRAM_CO}	Clock to RAM Output	—	1.24	—	1.33	—	1.53	ns
t_{LRAMAD_S}	Address Setup Time	-0.41	—	-0.40	—	-0.34	—	ns
t_{LRAMD_S}	Data Setup Time	0.21	—	0.22	—	0.25	—	ns
t_{LRAMWE_S}	Write Enable Setup Time	0.45	—	0.46	—	0.53	—	ns
t_{LRAMAD_H}	Address Hold Time	0.58	—	0.60	—	0.69	—	ns
t_{LRAMD_H}	Data Hold Time	0.11	—	0.11	—	0.13	—	ns
t_{LRAMWE_H}	Write Enable Hold Time	0.12	—	0.12	—	0.14	—	ns
$t_{LRAMCPW}$	Clock Pulse Width (High or Low)	2.91	—	3.00	—	3.45	—	ns
$t_{LRAMADO}$	Address to Output Delay	—	0.86	—	0.93	—	1.07	ns
Register/Latch Delays								
Registers								
t_{L_CO}	Register Clock to Output Delay	—	0.58	—	0.62	—	0.71	ns
t_{L_S}	Register Setup Time (Data before Clock)	0.14	—	0.14	—	0.16	—	ns
t_{L_H}	Register Hold Time (Data after Clock)	-0.12	—	-0.12	—	-0.10	—	ns
t_{LCE_S}	Register Clock Enable Setup Time	-0.11	—	-0.11	—	-0.09	—	ns
t_{LCE_H}	Register Clock Enable Hold Time	0.11	—	0.11	—	0.13	—	ns
Latches								
t_{L_GO}	Latch Gate to Output Delay	—	0.09	—	0.10	—	0.12	ns
t_{LL_S}	Latch Setup Time	0.14	—	0.14	—	0.16	—	ns
t_{LL_H}	Latch Hold Time	-0.12	—	-0.12	—	-0.10	—	ns
t_{LLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns

ispXPGA 1200B/C & ispXPGA 1200EB/EC PFU Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Reset/Set								
t_{LASSRO}	Asynchronous Set/Reset to Output	—	1.09	—	1.17	—	1.35	ns
$t_{LASSRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{LASSRR}	Asynchronous Set/Reset Recovery	—	0.51	—	0.55	—	0.63	ns
t_{LSSR_S}	Synchronous Set/Reset Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{LSSR_H}	Synchronous Set/Reset Hold Time	0.03	—	0.03	—	0.03	—	ns

1. Only available for ispXPGA 1200B and ispXPGA 1200EB (2.5V/3.3V) devices.
2. $t_{LCTHRUL}$ quoted bit by bit.

Timing v.2.1

ispXPGA 1200B/C & ispXPGA 1200EB/EC PIC Timing Parameters

Parameter	Description	-5[1]		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
Register/Latch Delays								
t_{IO_CO}	Register Clock to Output Delay	—	1.01	—	1.09	—	1.25	ns
t_{IO_S}	Register Setup Time (Data before Clock)	0.05	—	0.05	—	0.06	—	ns
t_{IO_H}	Register Hold Time (Data after Clock)	0.06	—	0.06	—	0.07	—	ns
t_{IOCE_S}	Register Clock Enable Setup Time	-0.03	—	-0.03	—	-0.03	—	ns
t_{IOCE_H}	Register Clock Enable Hold Time	0.13		0.13	—	0.15	—	ns
t_{IO_GO}	Latch Gate to Output Delay	—	0.85	—	0.91	—	1.05	ns
t_{IOL_S}	Latch Setup Time	0.05	—	0.05	—	0.06	—	ns
t_{IOL_H}	Latch Hold Time	0.06	—	0.06	—	0.07	—	ns
t_{IOLPD}	Latch Propagation Delay (Transparent Mode)	—	0.09	—	0.10	—	0.12	ns
t_{IOASRO}	Asynchronous Set/Reset to Output	—	1.17	—	1.26	—	1.45	ns
$t_{IOASRPW}$	Asynchronous Set/Reset Pulse Width	4.19	—	4.50	—	5.18	—	ns
t_{IOASRR}	Asynchronous Set/Reset Recovery Time	—	0.23	—	0.25	—	0.29	ns
Input/Output Delays								
t_{IOBUF}	Output Buffer Delay	—	0.99	—	1.06	—	1.22	ns
t_{IOIN}	Input Buffer Delay	—	0.71	—	0.76	—	0.87	ns
t_{IOEN}	Output Enable Delay	—	0.52	—	0.56	—	0.64	ns
t_{IODIS}	Output Disable Delay	—	-0.11	—	-0.10	—	-0.09	ns
t_{IOFT}	Feed-thru Delay	—	0.19	—	0.20	—	0.23	ns

1. Only available for ispXPGA 1200B and ispXPGA 1200EB (2.5V/3.3V) devices.

Timing v.2.1

ispXP sysCONFIG Port Timing Specifications

Symbol	Timing Parameter	Min.	Typ.	Max.	Units
sysCONFIG Write Cycle Timing					
t_{SUCS}	Input setup time of CS to CCLK rise	10	—	—	ns
t_{HCS}	Hold time of CS to CCLK Rise	0	—	—	ns
t_{SUWD}	Input setup time of write data to CCLK rise	12	—	—	ns
t_{HWD}	Hold time of write data to CCLK rise	0	—	—	ns
t_{PRGM}	Low time to reset device SRAM	5	—	50	ns
t_{WINIT}	INIT pulse width	—	—	5	ms
t_{IODISS}	User I/O disable	—	—	30	ns
t_{IOENSS}	User I/O enable	—	—	30	ns
t_{WH}	Write clock High pulse width	12	—	—	ns
t_{WL}	Write clock Low pulse width	12	—	—	ns
f_{MAXW}	Write f_{MAX}	—	—	33	MHz
sysCONFIG Read Cycle Timing					
t_{HREAD}	Hold time of READ to CCLK rise	0	—	—	ns
t_{SUREAD}	Input setup time of READ High to CCLK rise	30	—	—	ns
t_{RH}	READ clock high pulse width	12	—	—	ns
t_{RL}	READ clock low pulse width	15	—	—	ns
f_{MAXR}	Read f_{MAX}	—	—	33	MHz
t_{CORD}	Clock to out for read data	—	—	25	ns

Boundary Scan Timing

Parameter	Description	Min.	Max.	Units
t_{BTCP}	TCK [BSCAN] Clock Pulse Width	40	—	ns
t_{BTCPH}	TCK [BSCAN] Clock Pulse Width High	20	—	ns
t_{BTCPL}	TCK [BSCAN] Clock Pulse Width Low	20	—	ns
t_{BTS}	TCK [BSCAN] Setup Time	8	—	ns
t_{BTH}	TCK [BSCAN] Hold Time	10	—	ns
t_{BTRF}	TCK [BSCAN] Rise/Fall Time	50	—	mV/ns
t_{BTCO}	TAP Controller Falling Edge of Clock to Valid Output	—	18	ns
$t_{BTCODIS}$	TAP Controller Falling Edge of Clock to Valid Disable	—	18	ns
t_{BTCOEN}	TAP Controller Falling Edge of Clock to Valid Enable	—	18	ns
t_{BTCRS}	BSCAN Test Capture Register Setup Time	8	—	ns
t_{BTCRH}	BSCAN Test Capture Register Hold Time	25	—	ns
t_{BUTCO}	BSCAN Test Update Register, Falling Edge of Clock to Valid Output	—	45	ns
$t_{BTUODIS}$	BSCAN Test Update Register, Falling Edge of Clock to Valid Disable	—	20	ns
$t_{BTUPOEN}$	BSCAN Test Update Register, Falling Edge of Clock to Valid Enable	—	20	ns

ispXPGA Logic Signal Connections: 256-Ball fpBGA (Cont.)

256-fpBGA Ball	LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[2]
D16	BK5_IO15	HSI3A_SOUTN	72N/HSI3	BK5_IO13	HSI1A_SOUTN	61N/HSI1
E13	BK5_IO16	VREF5	73P/HSI3	BK5_IO14	VREF5	62P/HSI1
E14	BK5_IO17	-	73N/HSI3	BK5_IO15	-	62N/HSI1
E15	BK5_IO18	HSI3B_SINP	74P/HSI3	BK5_IO16	HSI1B_SINP	63P/HSI1
-	-	-	-	GND (Bank 5)	-	-
D15	BK5_IO19	HSI3B_SINN	74N/HSI3	BK5_IO17	HSI1B_SINN	63N/HSI1
C16	BK5_IO22	HSI3B_SOUTP	76P/HSI3	BK5_IO20	HSI1B_SOUTP	65P/HSI1
-	GND (Bank 5)	-	-	-	-	-
B16	BK5_IO23	HSI3B_SOUTN	76N/HSI3	BK5_IO21	HSI1B_SOUTN	65N/HSI1
D14	BK5_IO24	-	77P/HSI3	BK5_IO18	-	64P/HSI1
C15	BK5_IO25	-	77N/HSI3	BK5_IO19	-	64N/HSI1
C13	CFG0	-	-	CFG0	-	-
A15	DONE	-	-	DONE	-	-
A14	PROGRAMb	-	-	PROGRAMb	-	-
D12	BK6_IO0	INITb	78P	BK6_IO0	INITb	66P
C12	BK6_IO1	CCLK	78N	BK6_IO1	CCLK	66N
B14	BK6_IO2	-	79P	BK6_IO2	-	67P
-	GND (Bank 6)	-	-	-	-	-
B13	BK6_IO3	-	79N	BK6_IO3	-	67N
A13	BK6_IO4	CSb	80P	BK6_IO4	CSb	68P
-	-	-	-	GND (Bank 6)	-	-
A12	BK6_IO5	Read	80N	BK6_IO5	READ	68N
D11	BK6_IO6	DATA7	81P	BK6_IO6	DATA7	69P
C11	BK6_IO7	DATA6	81N	BK6_IO7	DATA6	69N
B12	BK6_IO8	-	82P	BK6_IO8	-	70P
B11	BK6_IO9	VREF6	82N	BK6_IO9	VREF6	70N
D10	BK6_IO10	DATA5	83P	BK6_IO10	DATA5	71P
-	GND (Bank 6)	-	-	-	-	-
C10	BK6_IO11	DATA4	83N	BK6_IO11	DATA4	71N
-	-	-	-	GND (Bank 6)	-	-
A11	BK6_IO14	DATA3	85P	BK6_IO14	DATA3	73P
A10	BK6_IO15	DATA2	85N	BK6_IO15	DATA2	73N
D9	BK6_IO16	-	86P	BK6_IO16	-	74P
C9	BK6_IO17	-	86N	BK6_IO17	-	74N
B10	BK6_IO18	DATA1	87P	BK6_IO18	DATA1	75P
-	GND (Bank 6)	-	-	GND (Bank 6)	-	-
B9	BK6_IO19	DATA0	87N	BK6_IO19	DATA0	75N
E9	BK6_IO20	-	88P	BK6_IO20	-	76P
E8	BK6_IO21	-	88N	BK6_IO21	-	76N
-	GND (Bank 6)	-	-	-	-	-
-	GND (Bank 7)	-	-	-	-	-
D8	BK7_IO0	-	91P	BK7_IO0	-	77P

ispXPGA Logic Signal Connections: 516-Ball fpBGA

516-Ball BGA Ball	LFX500			LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
E4	BK0_IO0	-	0P	BK0_IO0	-	0P/HSI0	NC	-	-
D3	BK0_IO1	-	0N	BK0_IO1	-	0N/HSI0	NC	-	-
E3	BK0_IO2	HSI0A_SOUTP	1P/HSI0	BK0_IO2	HSI0A_SOUTP	1P/HSI0	BK0_IO0	HSI0A_SOUTP	0P
-	GND (Bank 0)	-	-	GND (Bank 0)	-	-	-	-	-
F3	BK0_IO3	HSI0A_SOUTN	1N/HSI0	BK0_IO3	HSI0A_SOUTN	1N/HSI0	BK0_IO1	HSI0A_SOUTN	0N
C2	BK0_IO4	-	2P/HSI0	BK0_IO4	-	2P/HSI0	BK0_IO2	-	1P/HSI0
B1	BK0_IO5	-	2N/HSI0	BK0_IO5	-	2N/HSI0	BK0_IO3	-	1N/HSI0
G4	BK0_IO6	HSI0A_SINP	3P/HSI0	BK0_IO6	HSI0A_SINP	3P/HSI0	BK0_IO4	HSI0A_SINP	2P/HSI0
-	-	-	-	-	-	-	GND (Bank 0)	-	-
G3	BK0_IO7	HSI0A_SINN	3N/HSI0	BK0_IO7	HSI0A_SINN	3N/HSI0	BK0_IO5	HSI0A_SINN	2N/HSI0
C1	BK0_IO8	-	4P/HSI0	BK0_IO8	-	4P/HSI0	BK0_IO6	-	3P/HSI0
D2	BK0_IO9	VREF0	4N/HSI0	BK0_IO9	VREF0	4N/HSI0	BK0_IO7	VREF0	3N/HSI0
H4	BK0_IO10	HSI0B_SOUTP	5P/HSI0	BK0_IO10	HSI0B_SOUTP	5P/HSI0	BK0_IO8	HSI0B_SOUTP	4P/HSI0
-	GND (Bank 0)	-	-	GND (Bank 0)	-	-	-	-	-
H3	BK0_IO11	HSI0B_SOUTN	5N/HSI0	BK0_IO11	HSI0B_SOUTN	5N/HSI0	BK0_IO9	HSI0B_SOUTN	4N/HSI0
D1	BK0_IO12	-	6P/HSI0	BK0_IO12	-	6P/HSI0	BK0_IO10	-	5P/HSI0
E1	BK0_IO13	-	6N/HSI0	BK0_IO13	-	6N/HSI0	BK0_IO11	-	5N/HSI0
E2	BK0_IO14	HSI0B_SINP	7P/HSI0	BK0_IO14	HSI0B_SINP	7P/HSI0	BK0_IO12	HSI0B_SINP	6P/HSI0
-	-	-	-	-	-	-	GND (Bank 0)	-	-
F2	BK0_IO15	HSI0B_SINN	7N/HSI0	BK0_IO15	HSI0B_SINN	7N/HSI0	BK0_IO13	HSI0B_SINN	6N/HSI0
G2	BK0_IO16	-	8P/HSI0	NC	-	-	NC	-	-
F1	BK0_IO17	-	8N/HSI0	NC	-	-	NC	-	-
J3	BK0_IO18	HSI1A_SOUTP	9P	NC	-	-	NC	-	-
-	GND (Bank 0)	-	-	-	-	-	-	-	-
K3	BK0_IO19	HSI1A_SOUTN	9N	NC	-	-	NC	-	-
K4	BK0_IO20	-	10P	NC	-	-	NC	-	-
L4	BK0_IO21	-	10N	NC	-	-	NC	-	-
H2	BK0_IO22	HSI1A_SINP	11P	NC	-	-	NC	-	-
J2	BK0_IO23	HSI1A_SINN	11N	NC	-	-	NC	-	-
G1	BK0_IO24	-	12P	NC	-	-	NC	-	-
H1	BK0_IO25	-	12N	NC	-	-	NC	-	-
L3	BK0_IO26	HSI1B_SOUTP	13P	NC	-	-	NC	-	-
-	GND (Bank 0)	-	-	-	-	-	-	-	-
M3	BK0_IO27	HSI1B_SOUTN	13N	NC	-	-	NC	-	-
K2	BK0_IO28	-	14P	NC	-	-	NC	-	-
L2	BK0_IO29	-	14N	NC	-	-	NC	-	-
K1	BK0_IO30	HSI1B_SINP	15P	NC	-	-	NC	-	-
L1	BK0_IO31	HSI1B_SINN	15N	NC	-	-	NC	-	-
M2	BK0_IO32	-	16P	BK0_IO16	-	8P	NC	-	-
M1	BK0_IO33	-	16N	BK0_IO17	-	8N	NC	-	-
N3	BK0_IO34	PLL_FBK0	17P	BK0_IO18	PLL_FBK0	9P	BK0_IO14	PLL_FBK0	7P/HSI0
-	GND (Bank 0)	-	-	GND (Bank 0)	-	-	-	-	-
N4	BK0_IO35	PLL_RST1	17N	BK0_IO19	PLL_RST1	9N	BK0_IO15	PLL_RST1	7N/HSI0
N2	BK0_IO36	-	18P	BK0_IO20	-	10P	BK0_IO16	-	8P/HSI0
N1	BK0_IO37	PLL_FBK1	18N	BK0_IO21	PLL_FBK1	10N	BK0_IO17	PLL_FBK1	8N/HSI0
P1	BK0_IO38	PLL_RST0	19P	BK0_IO22	PLL_RST0	11P	BK0_IO18	PLL_RST0	9P
-	-	-	-	-	-	-	GND (Bank 0)	-	-
R1	BK0_IO39	-	19N	BK0_IO23	-	11N	BK0_IO19	-	9N
P3	BK0_IO40	CLK_OUT0	20P	BK0_IO24	CLK_OUT0	12P	BK0_IO20	CLK_OUT0	10P
-	GND (Bank 0)	-	-	-	-	-	-	-	-
P2	BK0_IO41	CLK_OUT1	20N	BK0_IO25	CLK_OUT1	12N	BK0_IO21	CLK_OUT1	10N

ispXPGA Logic Signal Connections: 516-Ball fpBGA (Cont.)

516-Ball BGA Ball	LFX500			LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AE3	BK1_IO33	-	37N/HSI2	NC	-	-	NC	-	-
AG1	BK1_IO34	-	38P/HSI2	NC	-	-	NC	-	-
AH1	BK1_IO35	-	38N/HSI2	NC	-	-	NC	-	-
AG2	BK1_IO36	-	39P/HSI2	NC	-	-	NC	-	-
AF3	BK1_IO37	-	39N/HSI2	NC	-	-	NC	-	-
AJ1	BK1_IO38	-	40P/HSI2	NC	-	-	NC	-	-
-	GND (Bank 1)	-	-	-	-	-	-	-	-
AH2	BK1_IO39	-	40N/HSI2	NC	-	-	NC	-	-
AG3	BK1_IO40	-	41P	BK1_IO24	-	25P/HSI1	NC	-	-
AF4	BK1_IO41	-	41N	BK1_IO25	-	25N/HSI1	NC	-	-
AK2	TCK	-	-	TCK	-	-	TCK	-	-
AJ3	TMS	-	-	TMS	-	-	TMS	-	-
AG5	TOE	-	-	TOE	-	-	TOE	-	-
AH4	BK2_IO0	-	42P	BK2_IO0	-	26P	BK2_IO0	-	22P
AK3	BK2_IO1	-	42N	BK2_IO1	-	26N	BK2_IO1	-	22N
AJ4	BK2_IO2	-	43P	BK2_IO2	-	27P	BK2_IO2	-	23P
-	GND (Bank 2)	-	-	GND (Bank 2)	-	-	-	-	-
AH5	BK2_IO3	-	43N	BK2_IO3	-	27N	BK2_IO3	-	23N
AK4	BK2_IO4	-	44P	BK2_IO4	-	28P	BK2_IO4	-	24P
-	-	-	-	-	-	-	GND (Bank 2)	-	-
AJ5	BK2_IO5	-	44N	BK2_IO5	-	28N	BK2_IO5	-	24N
AG7	BK2_IO6	-	45P	BK2_IO6	-	29P	BK2_IO6	-	25P
AH6	BK2_IO7	-	45N	BK2_IO7	-	29N	BK2_IO7	-	25N
AK5	BK2_IO8	-	46P	NC	-	-	NC	-	-
AJ6	BK2_IO9	-	46N	NC	-	-	NC	-	-
AG8	BK2_IO10	-	47P	NC	-	-	NC	-	-
-	GND (Bank 2)	-	-	-	-	-	-	-	-
AH7	BK2_IO11	-	47N	NC	-	-	NC	-	-
AK6	BK2_IO12	-	48P	NC	-	-	NC	-	-
AJ7	BK2_IO13	-	48N	NC	-	-	NC	-	-
AH8	BK2_IO14	-	49P	NC	-	-	NC	-	-
AG10	BK2_IO15	-	49N	NC	-	-	NC	-	-
AK7	BK2_IO16	-	50P	NC	-	-	NC	-	-
AJ8	BK2_IO17	-	50N	NC	-	-	NC	-	-
AH9	BK2_IO18	-	51P	NC	-	-	NC	-	-
-	GND (Bank 2)	-	-	-	-	-	-	-	-
AG11	BK2_IO19	-	51N	NC	-	-	NC	-	-
AK8	BK2_IO20	-	52P	BK2_IO8	-	30P	BK2_IO8	-	26P
AJ9	BK2_IO21	VREF2	52N	BK2_IO9	VREF2	30N	BK2_IO9	VREF2	26N
AH10	BK2_IO22	-	53P	BK2_IO10	-	31P	BK2_IO10	-	27P
-	-	-	-	GND (Bank 2)	-	-	-	-	-
AH11	BK2_IO23	-	53N	BK2_IO11	-	31N	BK2_IO11	-	27N
AJ10	BK2_IO24	-	54P	BK2_IO12		32P	BK2_IO12	-	28P
AK10	BK2_IO25	-	54N	BK2_IO13	-	32N	BK2_IO13	-	28N
AH12	BK2_IO26	-	55P	BK2_IO14	-	33P	BK2_IO14	-	29P
-	GND (Bank 2)	-	-	-	-	-	-	-	-
AJ11	BK2_IO27	-	55N	BK2_IO15	-	33N	BK2_IO15	-	29N
AK11	BK2_IO28	-	56P	NC	-	-	NC	-	-
AJ12	BK2_IO29	-	56N	NC	-	-	NC	-	-
AG13	BK2_IO30	-	57P	BK2_IO16	-	34P	BK2_IO16	-	30P
AH13	BK2_IO31	-	57N	BK2_IO17	-	34N	BK2_IO17	-	30N

ispXPGA Logic Signal Connections: 516-Ball fpBGA (Cont.)

516-Ball BGA Ball	LFX500			LFX200			LFX125		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AJ25	BK3_IO32	-	79P	NC	-	-	NC	-	-
AG24	BK3_IO33	-	79N	NC	-	-	NC	-	-
AK26	BK3_IO34	-	80P	BK3_IO20	-	49P	BK3_IO16	-	41P
-	-	-	-	-	-	-	GND (Bank 3)	-	-
AH25	BK3_IO35	-	80N	BK3_IO21	-	49N	BK3_IO17	-	41N
AJ26	BK3_IO36	-	81P	BK3_IO22	-	50P	BK3_IO18	-	42P
-	-	-	-	GND (Bank 3)	-	-	-	-	-
AH26	BK3_IO37	-	81N	BK3_IO23	-	50N	BK3_IO19	-	42N
AK27	BK3_IO38	-	82P	NC	-	-	NC	-	-
-	GND (Bank 3)	-	-	-	-	-	-	-	-
AJ27	BK3_IO39	-	82N	NC	-	-	NC	-	-
AG26	BK3_IO40	-	83P	BK3_IO24	-	51P	BK3_IO20	-	43P
AH27	BK3_IO41	-	83N	BK3_IO25	-	51N	BK3_IO21	-	43N
AK28	GSR	-	-	GSR	-	-	GSR	-	-
AJ28	DXP	-	-	DXP	-	-	DXP	-	-
AK29	DXN	-	-	DXN	-	-	DXN	-	-
AH29	BK4_IO0	-	84P	BK4_IO0	-	52P/HSI2	BK4_IO0	-	44P
AG28	BK4_IO1	-	84N	BK4_IO1	-	52N/HSI2	BK4_IO1	-	44N
AF27	BK4_IO2	-	85P/HSI3	NC	-	-	NC	-	-
-	GND (Bank 4)	-	-	-	-	-	-	-	-
AF28	BK4_IO3	-	85N/HSI3	NC	-	-	NC	-	-
AJ30	BK4_IO4	-	86P/HSI3	NC	-	-	NC	-	-
AH30	BK4_IO5	-	86N/HSI3	NC	-	-	NC	-	-
AG29	BK4_IO6	-	87P/HSI3	NC	-	-	NC	-	-
AF29	BK4_IO7	-	87N/HSI3	NC	-	-	NC	-	-
AE28	BK4_IO8	-	88P/HSI3	NC	-	-	NC	-	-
AD27	BK4_IO9	-	88N/HSI3	NC	-	-	NC	-	-
AG30	BK4_IO10	HSI3A_SINP	89P/HSI3	BK4_IO2	HSI2A_SINP	53P/HSI2	BK4_IO2	-	45P
-	GND (Bank 4)	-	-	GND (Bank 4)	-	-	-	-	-
AF30	BK4_IO11	HSI3A_SINN	89N/HSI3	BK4_IO3	HSI2A_SINN	53N/HSI2	BK4_IO3	-	45N
AD28	BK4_IO12	-	90P/HSI3	BK4_IO4	-	54P/HSI2	BK4_IO4	-	46P
-	-	-	-	-	-	-	GND (Bank 4)	-	-
AC27	BK4_IO13	-	90N/HSI3	BK4_IO5	-	54N/HSI2	BK4_IO5	-	46N
AE29	BK4_IO14	HSI3A_SOUTP	91P/HSI3	BK4_IO6	HSI2A_SOUTP	55P/HSI2	NC	-	-
AE30	BK4_IO15	HSI3A_SOUTN	91N/HSI3	BK4_IO7	HSI2A_SOUTN	55N/HSI2	NC	-	-
AD29	BK4_IO16	-	92P/HSI3	BK4_IO8	-	56P/HSI2	BK4_IO6	-	47P
AD30	BK4_IO17	VREF4	92N/HSI3	BK4_IO9	VREF4	56N/HSI2	BK4_IO7	VREF4	47N
AC28	BK4_IO18	HSI3B_SINP	93P	BK4_IO10	HSI2B_SINP	57P/HSI2	NC	-	-
-	GND (Bank 4)	-	-	GND (Bank 4)	-	-	-	-	-
AB28	BK4_IO19	HSI3B_SINN	93N	BK4_IO11	HSI2B_SINN	57N/HSI2	NC	-	-
AA27	BK4_IO20	PLL_RST4	94P	BK4_IO12	PLL_RST4	58P/HSI2	BK4_IO8	PLL_RST4	48P
AB29	BK4_IO21	PLL_RST5	94N	BK4_IO13	PLL_RST5	58N/HSI2	BK4_IO9	PLL_RST5	48N
AC29	BK4_IO22	HSI3B_SOUTP	95P	BK4_IO14	HSI2B_SOUTP	59P/HSI2	BK4_IO10	-	49P
AC30	BK4_IO23	HSI3B_SOUTN	95N	BK4_IO15	HSI2B_SOUTN	59N/HSI2	BK4_IO11	-	49N
AA28	BK4_IO24	-	96P	NC	-	-	NC	-	-
Y27	BK4_IO25	-	96N	NC	-	-	NC	-	-
Y28	BK4_IO26	-	97P	NC	-	-	NC	-	-
-	GND (Bank 4)	-	-	-	-	-	-	-	-
AA29	BK4_IO27	-	97N	NC	-	-	NC	-	-
Y29	BK4_IO28	-	98P	BK4_IO16	-	60P	BK4_IO12	-	50P
-	-	-	-	-	-	-	GND (Bank 4)	-	-

ispXPGA Logic Signal Connections: 680-Ball fpBGA (Cont.)

LFX1200			
680-Ball fpBGA	**Signal Name**	**Second Function**	**LVDS Pair/sysHSI Reserved[1]**
AU6	BK5_IO50	HSI9B_SINP	180P/HSI9
-	GND (Bank 5)	-	-
AV6	BK5_IO51	HSI9B_SINN	180N/HSI9
AR8	BK5_IO52	-	181P
AT7	BK5_IO53	-	181N
AU5	BK5_IO54	HSI9B_SOUTP	182P
AV5	BK5_IO55	HSI9B_SOUTN	182N
AW5	BK5_IO56	-	183P
AW4	BK5_IO57	-	183N
AT6	BK5_IO58	-	184P
-	GND (Bank 5)	-	-
AV4	BK5_IO59	-	184N
AR6	BK5_IO60	-	185P
AU4	BK5_IO61	-	185N
AT1	CFG0	-	-
AT3	DONE	-	-
AT2	PROGRAMb	-	-
AP4	BK6_IO0	INITb	186P
AP5	BK6_IO1	CCLK	186N
AR3	BK6_IO2	-	187P
-	GND (Bank 6)	-	-
AR2	BK6_IO3	-	187N
AP3	BK6_IO4	CSb	188P
AR1	BK6_IO5	Read	188N
AP2	BK6_IO6	-	189P
AP1	BK6_IO7	-	189N
AN4	BK6_IO8	-	190P
AM5	BK6_IO9	-	190N
AN3	BK6_IO10	-	191P
-	GND (Bank 6)	-	-
AN2	BK6_IO11	-	191N
AM4	BK6_IO12	VREF6	192P
AM3	BK6_IO13	-	192N
AN1	BK6_IO14	-	193P
AM2	BK6_IO15	-	193N
AL4	BK6_IO16	-	194P
AK5	BK6_IO17	-	194N
AM1	BK6_IO18	-	195P
-	GND (Bank 6)	-	-
AK4	BK6_IO19	-	195N
AL3	BK6_IO20	-	196P
AL2	BK6_IO21	-	196N
AL1	BK6_IO22	-	197P

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
AJ18	BK3_IO14	-	100P	BK3_IO14	-	70P
-	-	-	-	GND (Bank 3)	-	-
AK18	BK3_IO15	-	100N	BK3_IO15	-	70N
AE18	BK3_IO16	-	101P	BK3_IO16	-	71P
AD18	BK3_IO17	-	101N	BK3_IO17	-	71N
AJ19	BK3_IO18	-	102P	BK3_IO18	-	72P
-	GND (Bank 3)	-	-	-	-	-
AK19	BK3_IO19	-	102N	BK3_IO19	-	72N
AH19	BK3_IO20	-	103P	NC	-	-
AG19	BK3_IO21	-	103N	NC	-	-
AK20	BK3_IO22	-	104P	NC	-	-
AJ20	BK3_IO23	-	104N	NC	-	-
AF19	BK3_IO24	-	105P	NC	-	-
AE19	BK3_IO25	-	105N	NC	-	-
AH20	BK3_IO26	-	106P	NC	-	-
-	GND (Bank 3)	-	-	-	-	-
AG20	BK3_IO27	-	106N	NC	-	-
AF20	BK3_IO28	-	107P	NC	-	-
AE20	BK3_IO29	-	107N	NC	-	-
AJ21	BK3_IO30	-	108P	NC	-	-
AK21	BK3_IO31	-	108N	NC	-	-
AG21	BK3_IO32	-	109P	NC	-	-
AF21	BK3_IO33	-	109N	NC	-	-
AK22	BK3_IO34	-	110P	NC	-	-
-	GND (Bank 3)	-	-	-	-	-
AJ22	BK3_IO35	-	110N	NC	-	-
AE21	BK3_IO36	-	111P	NC	-	-
AD21	BK3_IO37	-	111N	NC	-	-
AG22	BK3_IO38	-	112P	NC	-	-
AF22	BK3_IO39	-	112N	NC	-	-
AG23	BK3_IO40	-	113P	BK3_IO22	-	74P
-	-	-	-	GND (Bank 3)	-	-
AH23	BK3_IO41	-	113N	BK3_IO23	-	74N
AJ23	BK3_IO42	-	114P	BK3_IO24	-	75P
-	GND (Bank 3)	-	-	-	-	-
AK23	BK3_IO43	-	114N	BK3_IO25	-	75N
AF23	BK3_IO44	-	115P	BK3_IO26	-	76P
AE23	BK3_IO45	-	115N	BK3_IO27	-	76N
AJ24	BK3_IO46	-	116P	BK3_IO28	-	77P
AK24	BK3_IO47	-	116N	BK3_IO29	-	77N
AH24	BK3_IO48	-	117P	BK3_IO21	-	73N
AG24	BK3_IO49	VREF3	117N	BK3_IO20	VREF3	73P

ispXPGA Logic Signal Connections: 900-Ball fpBGA (Cont.)

900 fpBGA Ball	LFX1200			LFX500		
	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]	Signal Name	Second Function	LVDS Pair/ sysHSI Reserved[1]
K30	BK5_IO22	HSI7B_SOUTP	166P/HSI8	BK5_IO22	HSI4B_SOUTP	116P/HSI4
-	-	-	-	GND (Bank 5)	-	-
K29	BK5_IO23	HSI7B_SOUTN	166N/HSI8	BK5_IO23	HSI4B_SOUTN	116N/HSI4
L28	BK5_IO24	-	167P/HSI8	BK5_IO24	-	117P/HSI5
L27	BK5_IO25	-	167N/HSI8	BK5_IO25	-	117N/HSI5
L26	BK5_IO26	HSI8A_SINP	168P/HSI8	BK5_IO26	HSI5A_SINP	118P/HSI5
-	GND (Bank 5)	-	-	-	-	-
L25	BK5_IO27	HSI8A_SINN	168N/HSI8	BK5_IO27	HSI5A_SINN	118N/HSI5
K27	BK5_IO28	-	169P/HSI8	BK5_IO28	-	119P/HSI5
K26	BK5_IO29	-	169N/HSI8	BK5_IO29	-	119N/HSI5
J30	BK5_IO30	HSI8A_SOUTP	170P/HSI8	BK5_IO30	HSI5A_SOUTP	120P/HSI5
-	-	-	-	GND (Bank 5)	-	-
J29	BK5_IO31	HSI8A_SOUTN	170N/HSI8	BK5_IO31	HSI5A_SOUTN	120N/HSI5
J26	BK5_IO32	-	171P/HSI8	NC	-	-
J27	BK5_IO33	-	171N/HSI8	NC	-	-
H30	BK5_IO34	HSI8B_SINP	172P/HSI8	NC	-	-
-	GND (Bank 5)	-	-	-	-	-
H29	BK5_IO35	HSI8B_SINN	172N/HSI8	NC	-	-
J25	BK5_IO36	-	173P/HSI9	NC	-	-
J24	BK5_IO37	-	173N/HSI9	NC	-	-
G30	BK5_IO38	HSI8B_SOUTP	174P/HSI9	NC	-	-
G29	BK5_IO39	HSI8B_SOUTN	174N/HSI9	NC	-	-
H27	BK5_IO40	-	175P/HSI9	NC	-	-
H28	BK5_IO41	-	175N/HSI9	NC	-	-
F30	BK5_IO42	HSI9A_SINP	176P/HSI9	NC	-	-
-	GND (Bank 5)	-	-	-	-	-
F29	BK5_IO43	HSI9A_SINN	176N/HSI9	NC	-	-
G27	BK5_IO44	-	177P/HSI9	NC	-	-
G28	BK5_IO45	-	177N/HSI9	NC	-	-
E30	BK5_IO46	HSI9A_SOUTP	178P/HSI9	NC	-	-
E29	BK5_IO47	HSI9A_SOUTN	178N/HSI9	NC	-	-
H26	BK5_IO48	-	179P/HSI9	BK5_IO33	-	121N/HSI5
H25	BK5_IO49	VREF5	179N/HSI9	BK5_IO32	VREF5	121P/HSI5
D30	BK5_IO50	HSI9B_SINP	180P/HSI9	BK5_IO34	HSI5B_SINP	122P/HSI5
-	GND (Bank 5)	-	-	-	-	-
D29	BK5_IO51	HSI9B_SINN	180N/HSI9	BK5_IO35	HSI5B_SINN	122N/HSI5
F28	BK5_IO52	-	181P	BK5_IO36	-	123P/HSI5
F27	BK5_IO53	-	181N	BK5_IO37	-	123N/HSI5
C30	BK5_IO54	HSI9B_SOUTP	182P	BK5_IO38	HSI5B_SOUTP	124P/HSI5
-	-	-	-	GND (Bank 5)	-	-
C29	BK5_IO55	HSI9B_SOUTN	182N	BK5_IO39	HSI5B_SOUTN	124N/HSI5
G26	BK5_IO56	-	183P	NC	-	-

"E-Series" Commercial (Cont.)

Part Number	Gates	Voltage	Speed Grade	Package	Balls
LFX500EC-03F900C	476K	1.8	-3	fpBGA	900
LFX1200EB-05F900C[2]	1.25M	2.5/3.3	-5	fpBGA	900
LFX1200EB-04F900C[2]	1.25M	2.5/3.3	-4	fpBGA	900
LFX1200EB-03F900C[2]	1.25M	2.5/3.3	-3	fpBGA	900
LFX1200EC-04F900C[2]	1.25M	1.8	-4	fpBGA	900
LFX1200EC-03F900C[2]	1.25M	1.8	-3	fpBGA	900
LFX1200EB-05FE680C[2]	1.25M	2.5/3.3	-5	fpSBGA	680
LFX1200EB-04FE680C[2]	1.25M	2.5/3.3	-4	fpSBGA	680
LFX1200EB-03FE680C[2]	1.25M	2.5/3.3	-3	fpSBGA	680
LFX1200EC-04FE680C[2]	1.25M	1.8	-4	fpSBGA	680
LFX1200EC-03FE680C[2]	1.25M	1.8	-3	fpSBGA	680

1. FH516 package was converted to F516 via PCN #09A-08.
2. Discontinued via PCN #03A-10.

"E-Series" Industrial

Part Number	Gates	Voltage	Speed Grade	Package	Balls
LFX125EB-04F256I	139K	2.5/3.3	-4	fpBGA	256
LFX125EB-03F256I	139K	2.5/3.3	-3	fpBGA	256
LFX125EC-03F256I	139K	1.8	-3	fpBGA	256
LFX125EB-04F516I	139K	2.5/3.3	-4	fpBGA	516
LFX125EB-03F516I	139K	2.5/3.3	-3	fpBGA	516
LFX125EC-03F516I	139K	1.8	-3	fpBGA	516
LFX125EB-04FH516I[1]	139K	2.5/3.3	-4	fpBGA	516
LFX125EB-03FH516I[1]	139K	2.5/3.3	-3	fpBGA	516
LFX125EC-03FH516I[1]	139K	1.8	-3	fpBGA	516
LFX200EB-04F256I	210K	2.5/3.3	-4	fpBGA	256
LFX200EB-03F256I	210K	2.5/3.3	-3	fpBGA	256
LFX200EC-03F256I	210K	1.8	-3	fpBGA	256
LFX200EB-04F516I	210K	2.5/3.3	-4	fpBGA	516
LFX200EB-03F516I	210K	2.5/3.3	-3	fpBGA	516
LFX200EC-03F516I	210K	1.8	-3	fpBGA	516
LFX200EB-04FH516I[1]	210K	2.5/3.3	-4	fpBGA	516
LFX200EB-03FH516I[1]	210K	2.5/3.3	-3	fpBGA	516
LFX200EC-03FH516I[1]	210K	1.8	-3	fpBGA	516
LFX500EB-04F516I	476K	2.5/3.3	-4	fpBGA	516
LFX500EB-03F516I	476K	2.5/3.3	-3	fpBGA	516
LFX500EC-03F516I	476K	1.8	-3	fpBGA	516
LFX500EB-04FH516I[1]	476K	2.5/3.3	-4	fpBGA	516
LFX500EB-03FH516I[1]	476K	2.5/3.3	-3	fpBGA	516
LFX500EC-03FH516I[1]	476K	1.8	-3	fpBGA	516
LFX500EB-04F900I	476K	2.5/3.3	-4	fpBGA	900
LFX500EB-03F900I	476K	2.5/3.3	-3	fpBGA	900
LFX500EC-03F900I	476K	1.8	-3	fpBGA	900

"E-Series" Commercial (Cont.)

Part Number	Gates	Voltage	Speed Grade	Package	Balls
LFX500EC-04FN900C	476K	1.8	-4	Lead-Free fpBGA	900
LFX500EC-03FN900C	476K	1.8	-3	Lead-Free fpBGA	900

"E-Series" Industrial

Part Number	Gates	Voltage	Speed Grade	Package	Balls
LFX125EB-04FN256I	139K	2.5/3.3	-4	Lead-Free fpBGA	256
LFX125EB-03FN256I	139K	2.5/3.3	-3	Lead-Free fpBGA	256
LFX125EC-03FN256I	139K	1.8	-3	Lead-Free fpBGA	256
LFX200EB-04FN256I	210K	2.5/3.3	-4	Lead-Free fpBGA	256
LFX200EB-03FN256I	210K	2.5/3.3	-3	Lead-Free fpBGA	256
LFX200EC-03FN256I	210K	1.8	-3	Lead-Free fpBGA	256
LFX500EB-04FN900I	476K	2.5/3.3	-4	Lead-Free fpBGA	900
LFX500EB-03FN900I	476K	2.5/3.3	-3	Lead-Free fpBGA	900
LFX500EC-03FN900I	476K	1.8	-3	Lead-Free fpBGA	900

For Further Information

In addition to this data sheet, the following Lattice technical notes may be helpful when designing with the ispXPGA Family:

- TN1028, ispXPGA Memory Usage Guidelines
- TN1003, sysCLOCK PLL Usage and Design Guidelines
- TN1000, sysIO Usage Guidelines for Lattice Devices
- TN1026, ispXP Configuration Usage Guidelines
- TN1020, sysHSI Usage Guidelines
- TN1043, Power Estimation in ispXPGA Devices

Revision History

Date	Version	Change Summary
—	—	Previous Lattice releases.
September 2003	07	Improved typical Icc data for LFX125B/C and LFX500B/C.
		Improved external switching characteristics timing numbers for LFX125B/C.
		Improved PIC timing numbers for LFX125B/C.
		Improved $t_{IOINDLY}$ timing numbers for LFX125B/C.
		Improved external switching characteristics timing numbers for LFX500B/C.
		Improved PIC timing numbers for LFX500B/C.
		Improved $t_{IOINDLY}$ timing numbers for LFX500B/C.
		Enhanced CDR functionality description.
		Logic Signal Connections and Signal Descriptions - removed CDRLOCK, LOSS and EXLOSS descriptions.
January 2004	07.1	Added lead-free package designators.
June 2004	08.0	Updated CDR specifications and reference notes. Removed Source Synchronous (SS:No CAL) mode references for the sysHSI blocks.
		Revised Figures 16 and 24 for clarification.
		Clarification of VCC sysHSI Block for 1.8V devices.
		Updated IIL and IIH max specification.
		Updated LVTTL and PCI 3.3 to support 5V tolerance.